5120732-1 ✓ ACTIVE

Z-PACK | Z-PACK HS3

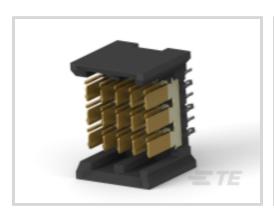
TE Internal #: 5120732-1

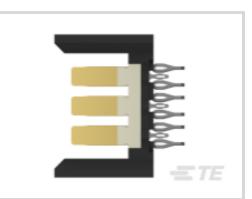
High Speed Backplane Connectors, 30 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 5 Column, PCB Mount Header, Z-PACK HS3

View on TE.com >



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors











Connector System: Board-to-Board

Number of Positions: 30

Row-to-Row Spacing: 2 mm [.078 in]

Mating Alignment: With

Mating Alignment Type: Polarization

Features

Product Type Features

| Backplane Module Type | Center |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Shroud Style | Partially Shrouded |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Stackable | No |
|------------------------|-----------------------|
| Backplane Architecture | Traditional Backplane |
| Number of Positions | 30 |
| Number of Rows | 6 |
| Number of Columns | 5 |
| PCB Mount Orientation | Vertical |

Electrical Characteristics

| Operating Voltage | 250 VAC |
|-------------------|---------|
|-------------------|---------|



Signal Characteristics

| Number of Differential Pairs per Column | 3 |
|--|----------------------------|
| Body Features | |
| Primary Product Color | Black |
| Contact Features | |
| Contact Mating Area Length | 6.8 mm[.268 in] |
| Contact Type | Pin |
| Contact Mating Area Plating Material Thickness | .5 μm[19.68 μin] |
| Contact Mating Area Plating Material | Tin |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Dual Beam |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| Contact Current Rating (Max) | 1.15 A |
| Termination Features | |
| Termination Post & Tail Length | 3.7 mm[.146 in] |
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
| Mechanical Attachment | |
| Guide Hardware | Without |
| Mating Retention | Without |
| PCB Mount Retention | With |
| PCB Mount Retention Type | Action/Compliant Tail |
| Mating Alignment | With |
| Mating Alignment Type | Polarization |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Number of Shrouded Sides | 2 |
| Housing Material | Polyester - GF |
| Centerline (Pitch) | 2.5 mm[.098 in] |
| Dimensions | |
| Connector Length | 12.41 mm[.489 in][.945 in] |
| Connector Height | 11.8 mm[.47 in] |
| | |



| Connector Width | 24 mm |
|-----------------------------|----------------------------|
| PCB Thickness (Recommended) | 1.4 mm |
| PCB Hole Diameter | .05 mm[.001 in] |
| Row-to-Row Spacing | 2 mm[.078 in] |
| Usage Conditions | |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Method | Tube |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Not applicable for solder process capability |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



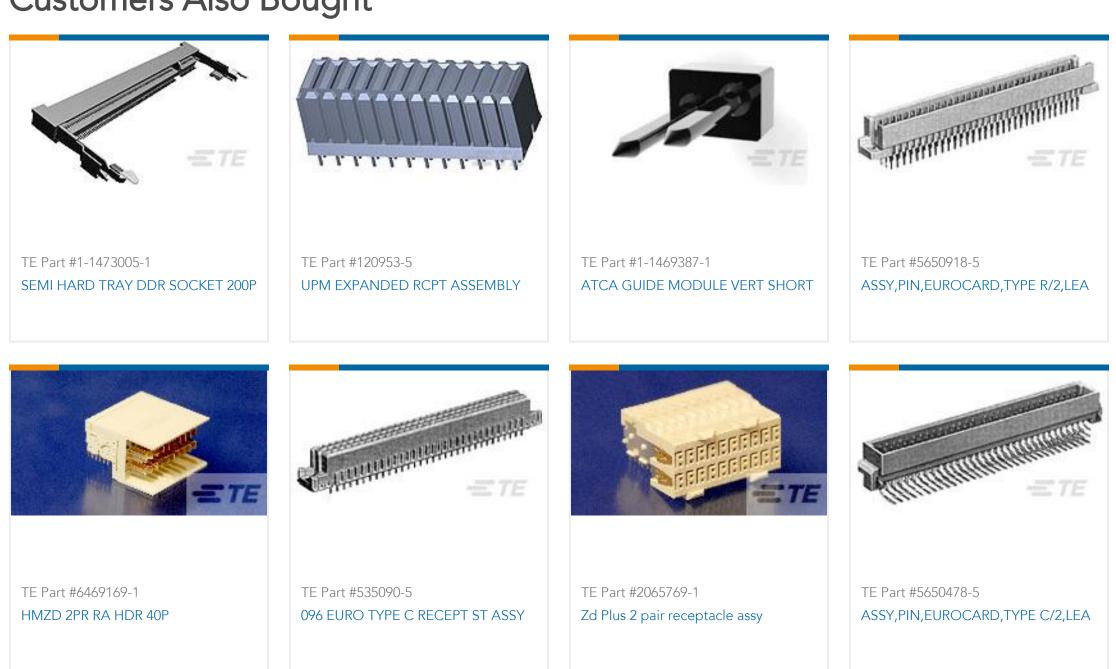
Compatible Parts



Also in the Series | Z-PACK HS3



Customers Also Bought







Documents

Product Drawings

Z-PACK HS3 HDR ASSY 6R 30P

English

CAD Files

Customer View Model

ENG_CVM_CVM_5120732-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5120732-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5120732-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK HS3 Connector

English

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English